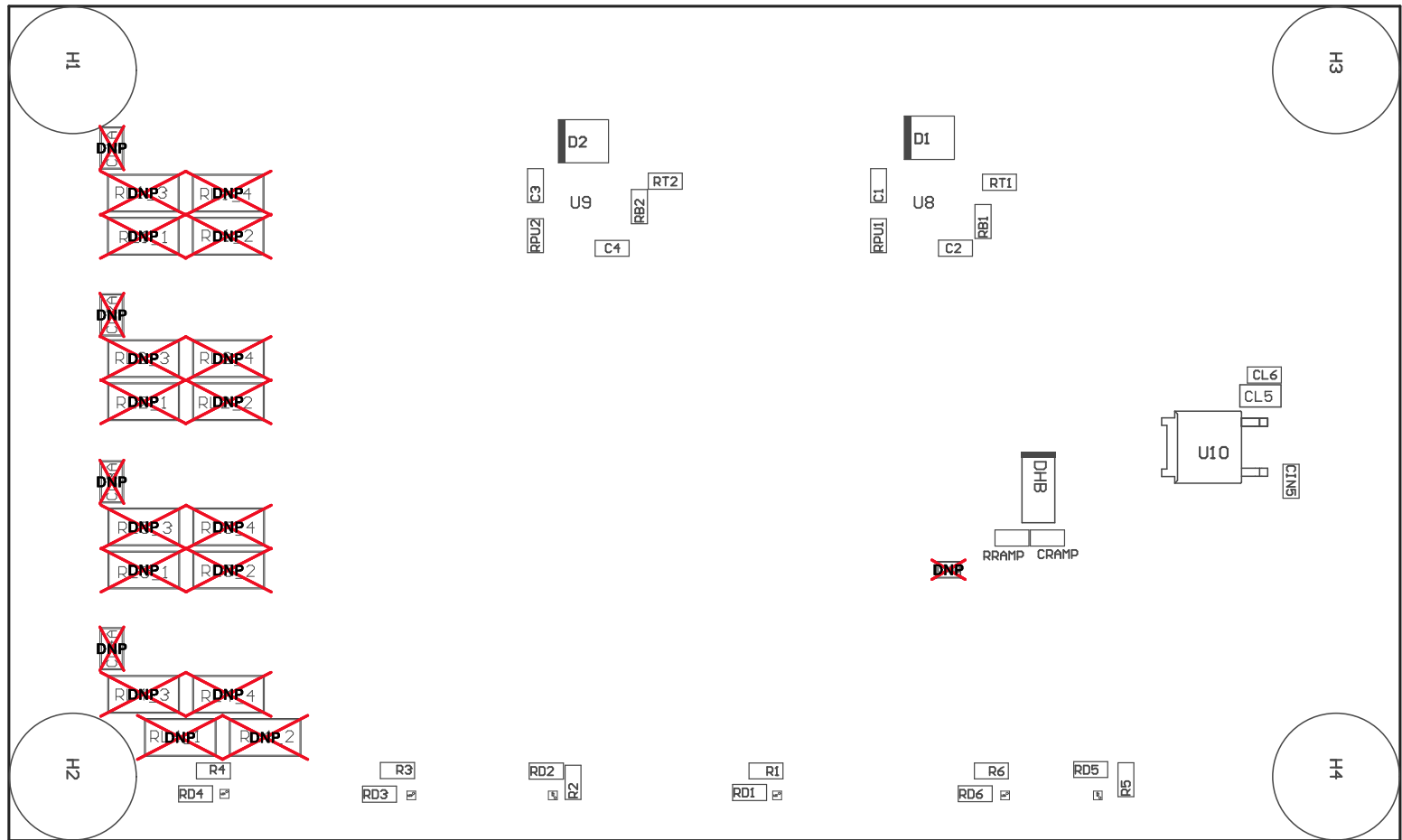


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00675	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-00675		
PLOT NAME = Top Assembly Drawing	GENERATED : 11/11/2015 10:10:41 AM		TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00675	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-00675		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/11/2015 10:10:42 AM	TEXAS INSTRUMENTS	

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